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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/672,375	09/28/2000	Makarem A. Hussein	04290.P6126D	8484
7:	590 05/16/2006	EXAMINER		
Blakey Sokoloff Taylor & Zafman LLP			OWENS, DOUGLAS W	
12400 Wilshire Boulevard Seventh Floor Los Angeles, CA 90025			ART UNIT	PAPER NUMBER
			2811	_

DATE MAILED: 05/16/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)		
Office Action Summary					
		09/672,375	HUSSEIN, MAKAREM A.		
	Onice Action Summary	Examiner	Art Unit		
	The MAILING DATE of this communication app	Douglas W. Owens	2811		
Period fo		rears on the cover sheet with the C	onespondence address		
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE of time may be available under the provisions of 37 CFR 1.15 SIX (6) MONTHS from the mailing date of this communication. To period for reply is specified above, the maximum statutory period or to reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONEL	lely filed the mailing date of this communication. O (35 U.S.C. § 133).		
Status					
1)⊠	Responsive to communication(s) filed on 30 Ja	anuary 2006.			
2a) <u></u> □	This action is FINAL . 2b)⊠ This action is non-final.				
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is				
	closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 45	i3 O.G. 213.		
Dispositi	on of Claims				
5)□ 6)⊠ 7)□	Claim(s) 12-17 is/are pending in the application 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 12-17 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/o	wn from consideration.			
Applicati	on Papers				
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Example.	epted or b) objected to by the Eddrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).		
Priority u	ınder 35 U.S.C. § 119				
a)[Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority documents application from the International Bureau See the attached detailed Office action for a list	s have been received. s have been received in Application rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National Stage		
2) Notice	t(s) te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:			

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114 was filed in this application after a decision by the Board of Patent Appeals and Interferences, but before the filing of a Notice of Appeal to the Court of Appeals for the Federal Circuit or the commencement of a civil action. Since this application is eligible for continued examination under 37 CFR 1.114 and the fee set forth in 37 CFR 1.17(e) has been timely paid, the appeal has been withdrawn pursuant to 37 CFR 1.114 and prosecution in this application has been reopened pursuant to 37 CFR 1.114. Applicant's submission filed on October 24, 2005 has been entered.

Claim Objections

2. Claim 16 is objected to because of the following informalities: in line 8, "devices" should be replaced with --device--. Appropriate correction is required.

Claim Rejections - 35 USC § 112

- 3. The following is a quotation of the first paragraph of 35 U.S.C. 112:
 - The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.
- 4. Claims 15 and 17 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. The specification and original claims do not

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include an embodiment wherein the seed layer is not over the surface of the circuit device. Each of the figures including the seed layer show that it lies directly over the circuit device.

Claim Rejections - 35 USC § 102

5. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 6. Claims 12 17 are rejected under 35 U.S.C. 102(e) as being anticipated by US Patent No. 6277,249 to Gopalraja et al.

Regarding claim 12, Gopalraja et al. teach an integrated circuit (Fig. 15, for example) comprising:

a substrate (210) having a circuit device (212);

a dielectric material (214) overlying the circuit device with a via (216) formed in the dielectric material to the circuit device, the via exposing a sidewall in the dielectric material and a surface of the circuit device;

a barrier material (222) substantially lining the sidewall;

a seed layer (226) on the barrier material and substantially lining the sidewall;

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a conductive material on the seed layer and directly contacting the surface of the circuit device (Col. 15, lines 45 and 46).

Regarding claim 13, Gopalraja et al. teach an integrated circuit, wherein the circuit device comprises an interconnection line.

Regarding claim 14, Gopalraja et al. teach an integrated circuit, wherein the conductive material is copper (Col. 15, lines 45 and 46).

Regarding claims 15 and 17, Gopalraja et al. teach an integrated circuit, wherein the seed layer can be used as a mask layer, and the barrier layer comprises an etch characteristic such that the barrier material can be selectively etched in the presence of the seed layer, since the barrier material is identical to that of the claimed invention (Col. 15, lines 60 - 63).

The requirement that the seed layer perform the function of a mask is not given patentable weight, since the seed layer taught by Gopalraja et al. is capable of performing the same function.

Regarding claim 16, Gopalraja et al. teach an integrated circuit comprising: a substrate (210) having a circuit device (212);

a dielectric material (214) overlying the circuit device with a via (216) formed in the dielectric material to the circuit device, the via exposing a sidewall in the dielectric material and a surface of the circuit device;

a barrier material (222) substantially lining the sidewall;

a seed layer (226) on the barrier material and substantially lining the sidewall, but not on the surface of the circuit device; and

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a conductive material in the via (Col. 15, lines 45 and 46);

wherein the seed layer and barrier material are formed so as to expose the circuit device at an end of the via.

Response to Arguments

7. Applicant's arguments with respect to claims 12 - 17 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas W. Owens whose telephone number is 571-272-1662. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Douglas W Owens

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Primary Examiner Art Unit 2811 Page 6

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